DECLARATION FOR PATENT APPLICATION

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As below named inventor, I declare:

The standard of the stand

SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE INCORPORATING MEMORY CELL TRANSISTOR AND LOGIC TRANSISTOR, AND METHOD OF MANUFACTURING THE SAME

the specification of which is attached hereto unless the following box is checked.

*Was filed on October 31, 2003 as United States Application or PCT International Application No. 10/699,202, and was amended on ______ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information of which is material to patentability as defined in 37 CFR 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365 (b) of any foreign application(s) for patent or inventor's certificate, or 35 U.S.C. 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed:

Country	Category	Application No.	Filing Date	Priority Claim
Japan	Patent	2003-120098	April 24, 2003	Yes

And I hereby appoint the registrants of Frommer Lawrence & Haug LLP, 745 Fifth Avenue, New York, NY 10151, Customer No. 20999, or any one of them. Send correspondence to Frommer Lawrence & Haug LLP, 745 Fifth Avenue, New York, NY 10151, Telephone No. (212)588-0800.

I declare further that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

DECLARATION FOR PATENT APPLICATION

I declare further that my mailing address is at c/o
Intellectual Property Division, Toshiba Corporation, 1-1, Shibaura
1-chome, Minato-ku, Tokyo 105-8001, Japan; and
that my citizenship and residence are as stated below next to my name:

Inventor: (Signature)	<u>Date</u>	Residence
	Date: FEB 9. 2004	
	Date: 1 11D. 3.2004	<u> </u>
Hidechi aveli	Citizen of: Japan	Kawasaki-shi, Japan
Hideaki Aochi		
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